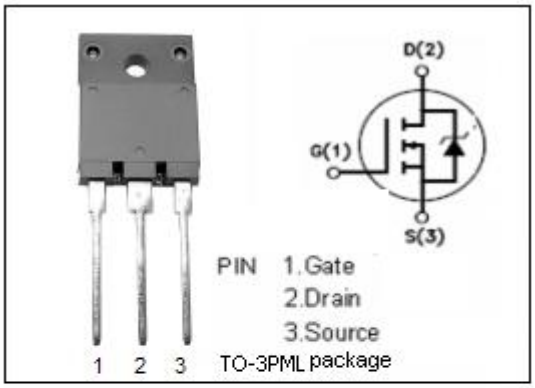
isc N-Channel MOSFET Transistor 2SK2224-01

DESCRIPTION

- Drain Current I_D=3A@ T_C=25℃
- Drain Source Voltage-
  : V_{DSS}= 900V(Min)
- Fast Switching Speed
- Minimum Lot-to-Lot variations for robust device performance and reliable operation

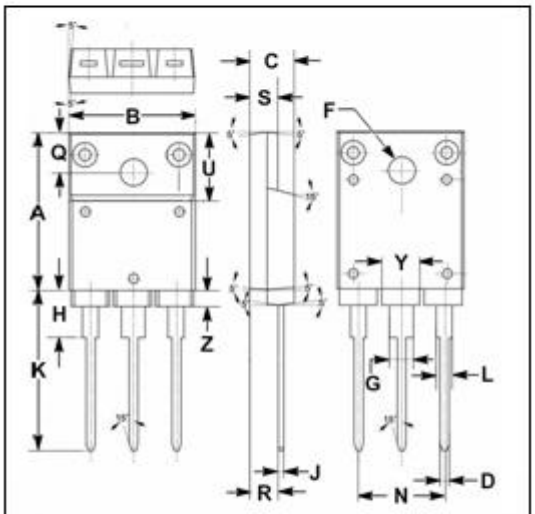


APPLICATIONS

- Switching regulators
- UPS
- DC-DC converters
- General purpose power amplifier

ABSOLUTE MAXIMUM RATINGS(T_a=25℃)

SYMBOL	ARAMETER	VALUE	UNIT
V_{DSS}	Drain-Source Voltage (V_{GS}=0)	900	V
V_{GS}	Gate-Source Voltage	±30	V
I_D	Drain Current-continuous@ TC=25℃	3	A
$I_{D(puls)}$	Pulse Drain Current	12	A
P_{tot}	Total Dissipation@T_C=25℃	50	W
T_j	Max. Operating Junction Temperature	150	℃
T_{stg}	Storage Temperature Range	-55~150	℃



DIM	mm MIN	MAX
A	19.90	20.10
B	15.90	16.10
C	5.50	5.70
D	0.90	1.10
F	3.30	3.50
G	2.90	3.10
H	5.90	6.10
J	0.595	0.605
K	22.30	22.50
L	1.90	2.10
N	10.80	11.00
Q	4.90	5.10
R	3.75	3.95
S	3.20	3.40
U	9.90	10.10
Y	4.70	4.90
Z	1.90	2.10

• THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	MAX	UNIT
$R_{th\ j\text{-}c}$	Thermal Resistance, Junction to Case	2.5	℃/W
$R_{th\ j\text{-}a}$	Thermal Resistance, Junction to Ambient	30	℃/W

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• ELECTRICAL CHARACTERISTICS (T_C=25℃)

SYMBOL	PARAMETER	CONDITIONS	MIN	TYPE	MAX	UNIT
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	V_{GS}= 0; I_D= 1mA	900			V
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}= V_{GS}; I_D=1mA	2.5	3.0	3.5	V
V_{SD}	Diode Forward On-Voltage	I_F=2 I_{DR} ;V_{GS}= 0		0.98	1.47	V
$R_{DS(on)}$	Drain-Source On-Resistance	V_{GS}= 10V; I_D= 1.5A		2.5	4.0	Ω
I_{GSS}	Gate-Body Leakage Current	V_{GS}= ±30V;V_{DS}= 0			±100	nA
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}= 900V; V_{GS}= 0			500	μA
Ciss	Input Capacitance	V_{DS}=25V; V_{GS}=0V; f_T=1MHz		1000	1500	pF
Crss	Reverse Transfer Capacitance			25	40	
Coss	Output Capacitance			90	135	
t_r	Rise Time	V_{GS}=10V; I_D=3A; V_{DD}=600V; R_{GS}=10Ω		10	15	ns
$t_{d(on)}$	Turn-on Delay Time			20	30	
t_f	Fall Time			15	25	
$t_{d(off)}$	Turn-off Delay Time			60	90	